

## **Excellent Integrated System Limited**

Stocking Distributor

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Vishay/Siliconix SI5915DC-T1-E3

For any questions, you can email us directly: sales@integrated-circuit.com





**Si5915DC** 

Vishay Siliconix

## **Dual P-Channel 1.8 V (G-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
	0.070 at V <sub>GS</sub> = - 4.5 V	- 4.6		
- 8	0.108 at V <sub>GS</sub> = - 2.5 V	- 3.7		
	0.162 at V <sub>GS</sub> = - 1.8 V	- 3.0		

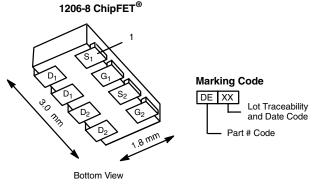
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Low Thermal Resistance
- 40 % Smaller Footprint than TSOP-6
- Compliant to RoHS Directive 2002/95/EC



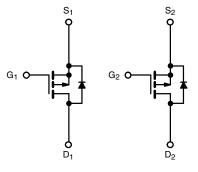
## APPLICATIONS

Load Switch or PA Switch for Portable Devices



Ordering Information: Si5915DC-T1-E3 (Lead (Pb)-free)

Si5915DC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	$T_A = 25$ °C, unles	ss otherwise r	oted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 8		V
Gate-Source Voltage		V <sub>GS</sub>	± 8		
Continuous Drain Current /T = 150 °C\8	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 4.6	- 3.4	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 85 °C		- 3.3	- 2.5	٨
Pulsed Drain Current		I <sub>DM</sub>	- 10		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 1.8	- 0.9	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.1	1.1	W
	T <sub>A</sub> = 85 °C		1.1	0.6	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) <sup>b, c</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	R <sub>thJA</sub>	50	60		
Maximum Junction-to-Ambient	Steady State		90	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40		

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See reliability manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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## Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI5915DC-T1-E3 - MOSFET 2P-CH 8V 3.4A 1206-8

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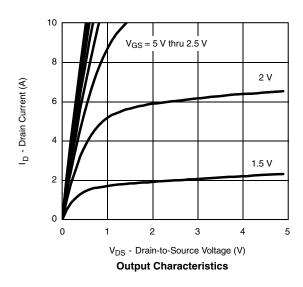
Parameter	Symbol	Test Conditions		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45			٧	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 6.4 V, V <sub>GS</sub> = 0 V			- 1	μА	
	I <sub>DSS</sub>	$V_{DS} = -6.4 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 10			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.4 A		0.058	0.070		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 2.7 A		0.090	0.108	Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1 A		0.131	0.162		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 3.4 A		8		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 0.9 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			5.9	9	nC	
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> = - 4 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.4 A		1.3			
Gate-Drain Charge	$Q_{gd}$			1.4			
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD} = -4 \text{ V}, R_L = 4 \Omega$		70	110	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -1$ A, $V_{GEN} = -4.5$ V, $R_g = 6 \Omega$		35	55		
Fall Time	t <sub>f</sub>			35	55		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 0.9 A, dI/dt = 100 A/μs		30	60		

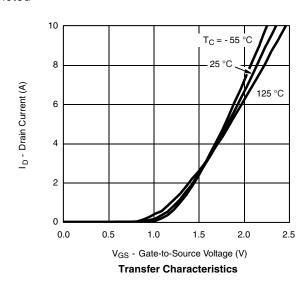
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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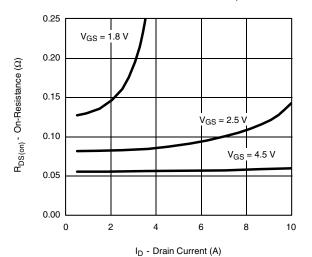




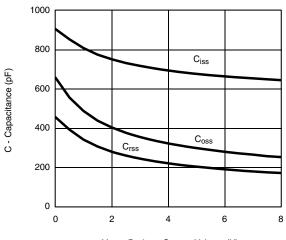
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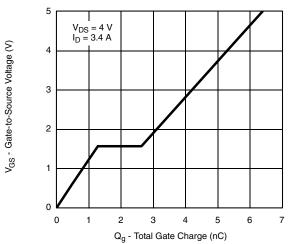
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On-Resistance vs. Drain Current



 $V_{DS}$  - Drain-to-Source Voltage (V)  $\label{eq:VDS} \mbox{\bf Capacitance}$ 



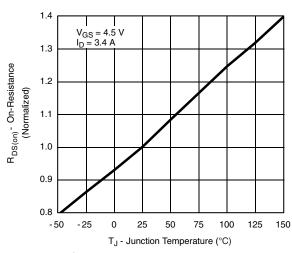
T<sub>J</sub> = 150 °C

T<sub>J</sub> = 25 °C

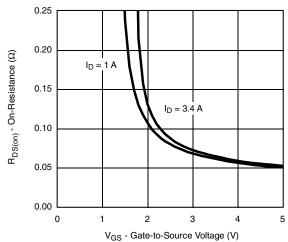
T<sub>J</sub> = 25 °C

**Gate Charge** 

 $\label{eq:VSD} \mbox{$V_{SD}$ - Source-to-Drain Voltage (V)}$  Source-Drain Diode Forward Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

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Source Current (A)

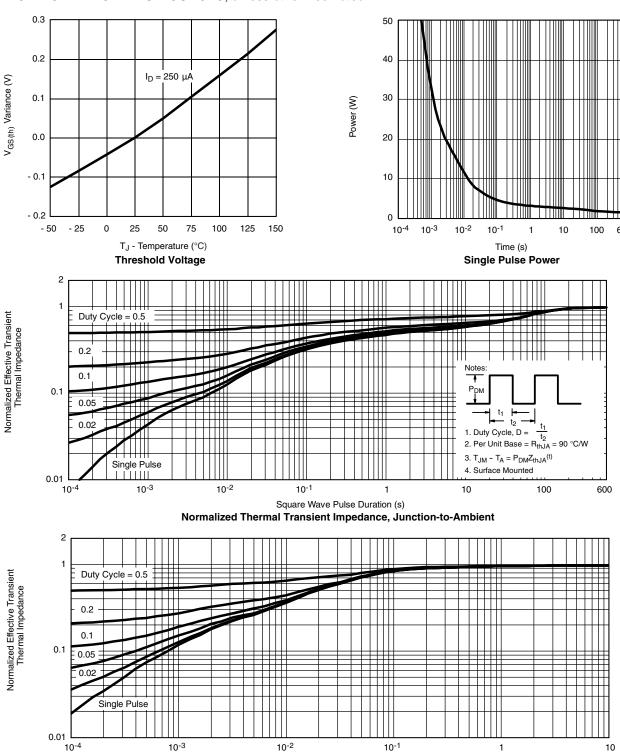


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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppq?70693">www.vishay.com/ppq?70693</a>.

Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Foot



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Datasheet of SI5915DC-T1-E3 - MOSFET 2P-CH 8V 3.4A 1206-8

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